# BTS50080-1TEA

Smart High-Side Power Switch PROFET™
One Channel

**Automotive Power** 





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# Smart High-Side Power Switch PROFET™ One Channel

BTS50080-1TEA

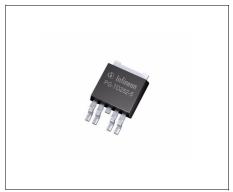




### 1 Overview

#### **Features**

- · Part of scalable product family
- Load current sense
- Reversave<sup>™</sup>
- · Very low standby current
- Current controlled input pin
- Improved electromagnetic compatibility (EMC)
- · Fast demagnetization of inductive loads
- Stable behavior at under-voltage
- Green Product (RoHS compliant)
- · AEC Qualified



PG-TO252-5-11

Operating voltage	$V_{ m bb(on)}$	5.5 30 V
Minimum overvoltage protection	$V_{ON(CL)}$	39 V
Maximum on-state resistance at 150°C	$R_{DS(ON)}$	16 mΩ
Nominal load current	$I_{L(nom)}$	10 A
Minimum load current limitation peak	$I_{Lpeak(SC)}$	70 A
Maximum stand-by current for whole device with load at $T_i$ = 25 °C	$I_{bb(OFF)}$	6 μΑ

The BTS50080-1TEA is a one channel high-side power switch in PG-TO252-5-11 package providing embedded protective functions.

The power transistor is built by a N-channel vertical power MOSFET with charge pump. The design is based on Smart SIPMOS chip on chip technology.

The BTS50080-1TEA has a current controlled input and offers a diagnostic feedback with load current sense and a defined fault signal in case of overload operation, overtemperature shutdown and/or short circuit shutdown.

Туре	Package	Marking
BTS50080-1TEA	PG-TO252-5-11	S50080A

Datasheet 3 Rev. 1.0, 2008-08-28



# Smart High-Side Power Switch BTS50080-1TEA

Overview

#### **Protective Functions**

- Reversave<sup>™</sup>, channel switches on in case of reverse polarity
- · Reverse battery protection without external components
- Short circuit protection with latch
- Overload protection
- · Multi-step current limitation
- Thermal shutdown with restart
- Overvoltage protection (including load dump)
- · Loss of ground protection
- Loss of V<sub>bb</sub> protection (with external diode for charged inductive loads)
- Electrostatic discharge protection (ESD)

#### **Diagnostic Functions**

- Proportional load current sense (with defined fault signal in case of overload operation, overtemperature shutdown and/or short circuit shutdown)
- Open load detection in ON-state by load current sense

#### **Applications**

- μC compatible high-side power switch with diagnostic feedback for 12 V grounded loads
- All types of resistive, inductive and capacitive loads
- · Most suitable for loads with high inrush currents, so as lamps
- · Replaces electromechanical relays, fuses and discrete circuits

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**Block Diagram and Terms** 

# 2 Block Diagram and Terms

# 2.1 Block Diagram

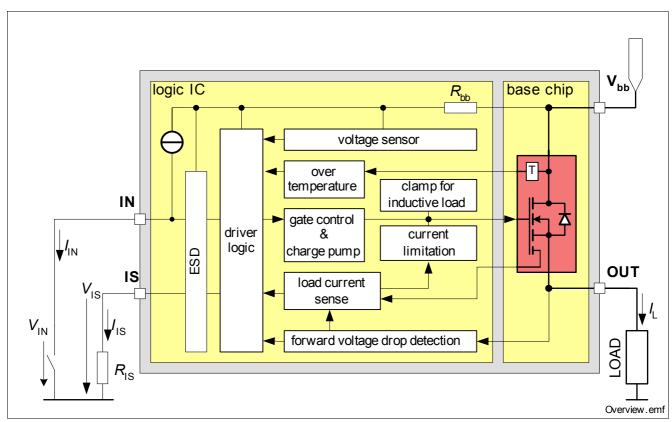


Figure 1 Block Diagram

#### 2.2 Terms

Following figure shows all terms used in this data sheet.

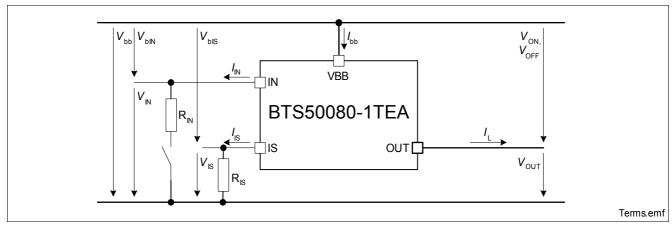


Figure 2 Terms

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**Pin Configuration** 

# 3 Pin Configuration

# 3.1 Pin Assignment BTS50080-1TEA

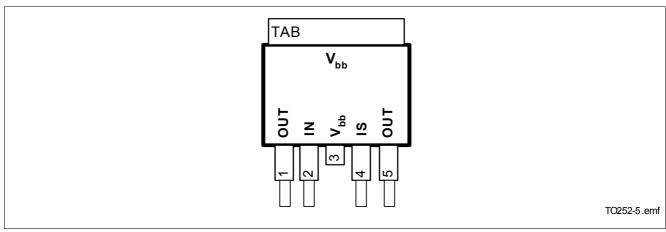


Figure 3 Pin Configuration

### 3.2 Pin Definitions and Functions

Pin	Symbol	Function
1	OUT	Output; output to the load; pin 1 and 5 must be externally shorted. 1)
2	IN	Input; activates the power switch if shorted to ground.
3	$V_{bb}$	<b>Supply Voltage</b> ; positive power supply voltage; tab and pin 3 are internally shorted.
4	IS	<b>Sense Output;</b> Diagnostic feedback; provides at normal operation a sense current proportional to the load current; in case of overload, overtemperature and/or short circuit a defined current is provided (see <b>Table 1 "Truth Table" on Page 21</b> ).
5	OUT	Output; output to the load; pin 1 and 5 must be externally shorted. 1)
TAB	V <sub>bb</sub>	Supply Voltage; positive power supply voltage; tab and pin 3 are internally shorted.

<sup>1)</sup> Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability, the clamping capability and decrease the current sense accuracy.

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**General Product Characteristics** 

### 4 General Product Characteristics

# 4.1 Absolute Maximum Ratings

#### Absolute Maximum Ratings 1)

 $T_i = 25$ °C (unless otherwise specified)

Pos.	Parameter	Symbol	Limi	t Values	Unit	Conditions
			Min.	Max.		
Supply	Voltages					
4.1.1	Supply voltage	$V_{bb}$	-16	38	V	_
4.1.2	Supply voltage for short circuit protection (single pulse) <sup>2)</sup>	$V_{\rm bb(SC)}$	0	30	V	-
4.1.3	Supply Voltage for Load Dump protection <sup>3)</sup>	$V_{ m bb(LD)}$	_	45	V	$R_{\rm l}$ = 2 $\Omega$ , $R_{\rm L}$ = 1.5 $\Omega$
Logic P	ins		•	•		
4.1.4	Voltage at input pin	$V_{bIN}$	-16	63	V	_
4.1.5	Current through input pin	$I_{IN}$	-140	15	mA	_
4.1.6	Voltage at current sense pin	$V_{bIS}$	-16	63	V	_
4.1.7	Current through sense pin	$I_{IS}$	-140	15	mA	_
4.1.8	Input voltage slew rate 4)	$\mathrm{d}V_{\mathrm{bIN}}/\mathrm{d}t$	-20	20	V/µs	_
Power S	Stages					
4.1.9	Load current 5)	$I_L$	-	$I_{Lx(SC)}$	Α	_
4.1.10	Maximum energy dissipation per channel (single pulse)	$E_{AS}$	-	0.3	J	$V_{\rm bb}$ = 12 V, $I_{\rm L(0)}$ = 20 A, $T_{\rm j(0)}$ = 150°C
Temper	atures					
4.1.11	Junction temperature	$T_{i}$	-40	150	°C	_
4.1.12	Storage temperature	$T_{stg}$	-55	150	°C	_
ESD Su	sceptibility					
4.1.13	ESD susceptibility HBM Pin 2 (IN) Pin 4 (IS) Pin1/5 (OUT)	$V_{ESD}$	-2 -2 -4	2 2 4	kV	according to EIA/JESD 22-/ 114B

- 1) Not subject to production test, specified by design.
- 2) Short circuit is defined as a combination of remaining resistances and inductances. See Figure 13.
- 3) Load Dump is specified in ISO 7637, R<sub>I</sub> is the internal resistance of the Load Dump pulse generator.
- 4) Slew rate limitation can be achieved by means of using a series resistor for the small signal driver or in series in the input path. A series resistor  $R_{\text{IN}}$  in the input path is also required for reverse operation at  $V_{\text{bb}} \le$  -16V. See also **Figure 14**.
- 5) Current limitation is a protection feature. Operation in current limitation is considered as "outside" normal operating range. Protection features are not designed for continuous repetitive operation.

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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# Smart High-Side Power Switch BTS50080-1TEA

#### **General Product Characteristics**

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

#### 4.2 Thermal Resistance

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
4.2.1	Junction to Case <sup>1)</sup>	$R_{thJC}$	_	-	1.1	K/W	_
4.2.2	Junction to Ambient 1)	$R_{thJA}$				K/W	_
	free air		-	80	-		
	device on small PCB 2)		-	45	-		
	device on standard PCB3)		-	22	-		

<sup>1)</sup> Not subject to production test, specified by design.

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<sup>2)</sup> Device mounted on PCB (50 mm x 50 mm x 1.5mm epoxy, FR4) with 6 cm $^2$  copper heatsinking area (one layer, 70  $\mu$ m thick) for  $V_{bb}$  connection. PCB is vertical without blown air.

<sup>3)</sup> Specified  $R_{\text{thJA}}$  value is according to Jedec JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The Product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70 $\mu$ m Cu, 2 x 35 $\mu$ m Cu). Where applicable a thermal via array under the exposed pad contacted the first inner copper layer.



# 5 Power Stages

The power stage is built by a N-channel vertical power MOSFET (DMOS) with charge pump.

# 5.1 Input Circuit

**Figure 4** shows the input circuit of the BTS50080-1TEA. The current source to  $V_{bb}$  ensures that the device switches off in case of open input pin. The zener diode protects the input circuit against ESD pulses.

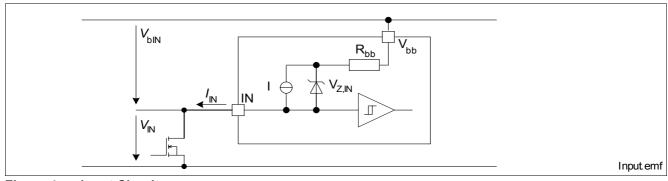


Figure 4 Input Circuit

A high signal at the required external small signal transistor pulls the input pin to ground. A logic supply current  $I_{IN}$  is flowing and the power DMOS switches on with a dedicated slope, which is optimized in terms of EMC emission.

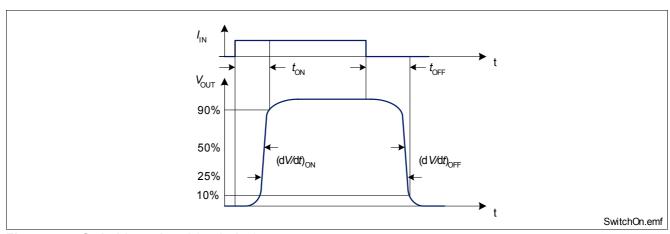


Figure 5 Switching a Load (resistive)

### 5.2 Output On-State Resistance

The on-state resistance  $R_{\rm DS(ON)}$  depends on the supply voltage as well as the junction temperature  $T_{\rm j}$ . Figure 6 shows these dependencies for the typical on-state resistance. The voltage drop in reverse polarity mode is described in Section 6.3.

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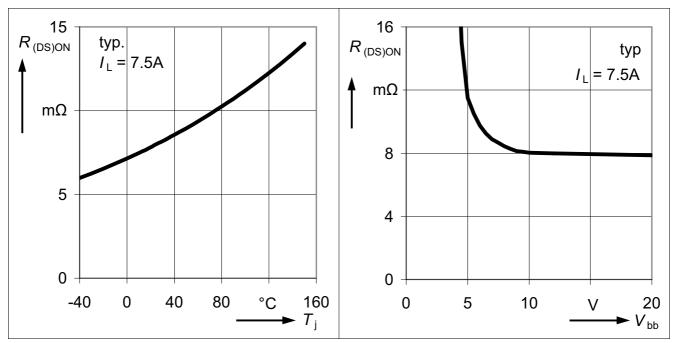


Figure 6 Typical On-State Resistance

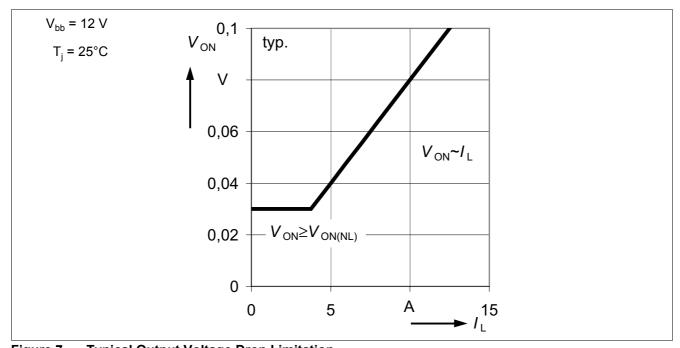


Figure 7 Typical Output Voltage Drop Limitation

# 5.3 Output Inductive Clamp

When switching off inductive loads, the output voltage  $V_{\text{OUT}}$  drops below ground potential due to the involved inductance (  $-\text{d}i_{\text{L}}/\text{d}t = -v_{\text{L}}/\text{L}$ ;  $-V_{\text{OUT}} \cong -V_{\text{L}}$ ).



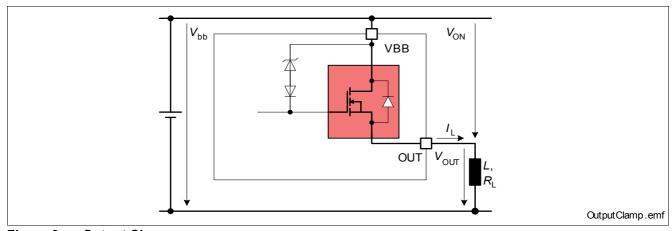


Figure 8 Output Clamp

To prevent destruction of the device, there is a voltage clamp mechanism implemented that keeps the voltage drop across the device at a certain level ( $V_{\rm ON(CL)}$ ). See **Figure 8** and **Figure 9** for details. The maximum allowed load inductance is limited.

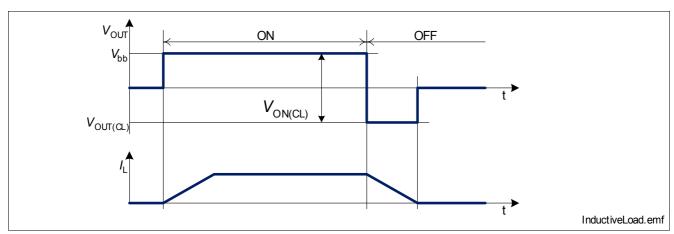


Figure 9 Switching an Inductance

#### 5.3.1 Maximum Load Inductance

While de-energizing inductive loads, energy has to be dissipated in the BTS50080-1TEA. This energy can be calculated via the following equation:

$$E = V_{\text{ON(CL)}} \cdot \left[ \frac{V_{\text{bb}} - \left| V_{\text{ON(CL)}} \right|}{R_{\text{L}}} \cdot \ln \left( 1 + \frac{R_{\text{L}} \cdot I_{\text{L}}}{\left| V_{\text{ON(CL)}} \right| - V_{\text{bb}}} \right) + I_{\text{L}} \right] \cdot \frac{L}{R_{\text{L}}}$$

In the event of de-energizing very low ohmic inductances ( $R_L \approx 0$ ) the following, simplified equation can be used:

$$E = \frac{1}{2}LI_{L}^{2} \cdot \frac{|V_{\text{ON(CL)}}|}{|V_{\text{ON(CL)}}| - V_{\text{bb}}}$$

The energy, which is converted into heat, is limited by the thermal design of the component. For given starting currents the maximum allowed inductance is therefore limited. See **Figure 10** for the maximum allowed inductance at  $V_{\rm bb}$ =12V.

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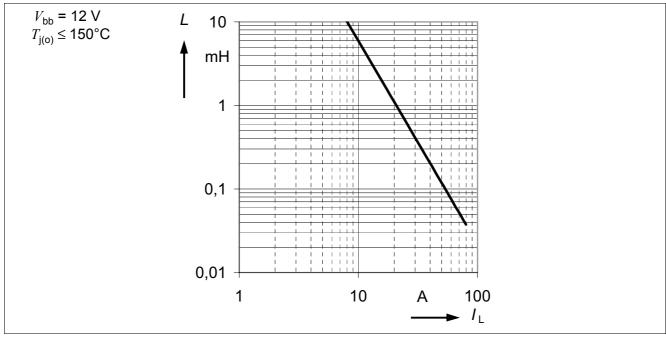


Figure 10 Maximum load inductance for single pulse,  $T_{j(0)} \le 150$ °C.



#### 5.4 **Electrical Characteristics**

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
Genera	al						
5.4.1	Operating voltage 1)	$V_{ m bb(on)}$	5.5	-	30	V	$V_{IN} = 0 \; V$
5.4.2	Undervoltage shutdown <sup>2)</sup>	$V_{bIN(u)}$	-	2.5	3.5	V	T <sub>i</sub> = 25 °C
5.4.3	Undervoltage restart of charge pump	$V_{ m bb(ucp)}$	-	4	5.5	V	_
5.4.4	Operating current	$I_{IN}$	-	1.4	2.2	mA	_
5.4.5	Stand-by current $T_j$ = -40 °C, $T_j$ = 25 °C $T_j \le 120$ °C <sup>2)</sup> $T_j$ = 150 °C	$I_{\mathrm{bb}(\mathrm{OFF})}$	- - -	3 3 6	6 6 14	μΑ	I <sub>IN</sub> = 0 A
Input c	haracteristics					-	
5.4.6	Input current for turn-on	$I_{IN(on)}$	-	1.4	2.2	mA	$V_{\rm bIN} \ge V_{\rm bb(ucp)}$ - $V_{\rm IN}$
5.4.7	Input current for turn-off	$I_{IN(off)}$	-	-	30	μΑ	_
Output	characteristics						
5.4.8	On-state resistance $T_{\rm j}$ = 25 °C $T_{\rm j}$ = 150 °C $V_{\rm bb}$ = 5.5 V, $T_{\rm j}$ = 25 °C $V_{\rm bb}$ = 5.5 V, $T_{\rm i}$ = 150 °C	R <sub>DS(ON)</sub>	- - -	8 14 10 18	- 16 - 22	mΩ	$V_{\rm IN}$ = 0 V, $I_{\rm L}$ = 7.5 A, (Tab to pin 1 and 5
5.4.9	Output voltage drop limitation at small load currents	V <sub>ON(NL)</sub>	-	30	65	mV	-
5.4.10	Nominal load current (Tab to pin 1 and 5) 3) 4)	$I_{L(nom)}$	-	10	-	A	$T_{\rm a}$ = 85 °C, $V_{\rm ON} \le 0.5 \text{ V},$ $T_{\rm i} \le 150 \text{ °C}$
5.4.11	Output clamp	$V_{ON(CL)}$	39	42	-	V	$I_{\rm L}$ = 40 mA, $T_{\rm i}$ = 25 °C
5.4.12	Inverse current output voltage drop <sup>2) 5)</sup> (Tab to pin 1 and 5)	$-V_{ m ON(inv)}$				mV	$I_{L}$ = -7.5 A, $R_{IS}$ = 1 k $\Omega$
	$T_{\rm j}$ = 25 °C $T_{\rm j}$ = 150 °C		-	700 300	-		
Timing	S						
5.4.13	Turn-on time to 90% $V_{\mathrm{OUT}}$	$t_{ON}$	-	300	500	μs	$R_{\rm L}$ = 2.2 $\Omega$
5.4.14	Turn-off time to 10% $V_{\mathrm{OUT}}$	t <sub>OFF</sub>	-	300	500	μs	$R_{\rm L}$ = 2.2 $\Omega$
5.4.15	Turn-on delay after inverse operation <sup>2)</sup>	$t_{\sf d(inv)}$	-	1	-	ms	$V_{\rm bb} > V_{\rm OUT},$ $V_{\rm IN(inv)} = V_{\rm IN(fwd)} = 0$

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# Smart High-Side Power Switch BTS50080-1TEA

**Power Stages** 

 $V_{\rm bb}$  = 12 V,  $T_{\rm i}$  = -40 ... 150 °C (unless otherwise specified) Typical values are given at  $V_{\rm bb}$  = 12 V,  $T_{\rm i}$  = 25 °C

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
5.4.16	Slew rate On 25% to 50% V <sub>OUT</sub>	$(dV/dt)_{ON}$	-	0.3	0.5	V/µs	$R_{\rm L}$ = 2.2 $\Omega$
5.4.17	Slew rate Off 50% to 25% V <sub>OUT</sub>	$-(dV/dt)_{OFF}$	-	0.3	0.6	V/µs	$R_{\rm L}$ = 2.2 $\Omega$

- 1) Please mind the limitations of the embedded protection functions. See Chapter 4.1 and Chapter 6 for details.
- 2) Not subject to production test, specified by design
- 3) Device mounted on PCB (50 mm x 50 mm x 1.5mm epoxy, FR4) with 6 cm $^2$  copper heatsinking area (one layer, 70  $\mu$ m thick) for  $V_{\rm bb}$  connection. PCB is vertical without blown air.
- 4) Not subject to production test, parameters are calculated from  $R_{\rm DS(ON)}$  and  $R_{\rm th}$
- 5) During inverse operation ( $I_{\rm L}$  < 0 A,  $V_{\rm bIN}$  > 0 V), a current through the intrinsic body diode causing a voltage drop of  $V_{\rm ON(inv)}$  results in a delayed switch on with a time delay  $t_{\rm d(inv)}$  after the transition from inverse to forward operation. A sense current  $I_{\rm IS(fault)}$  can be provided by the pin IS until standard forward operation is reached.

Note: Characteristics show the deviation of parameter at the given supply voltage and junction temperature.

Typical values show the typical parameters expected from manufacturing.

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#### 6 Protection Functions

The device provides embedded protective functions. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are neither designed for continuous nor repetitive operation.

#### 6.1 Overload Protection

The load current  $I_{\rm L}$  is limited by the device itself in case of overload or short circuit to ground. There are multiple steps of current limitation  $I_{\rm Lx(SC)}$  which are selected automatically depending on the voltage drop  $V_{\rm ON}$  across the power DMOS. Please note that the voltage at the OUT pin is  $V_{\rm bb}$  -  $V_{\rm ON}$ . Figure 11 shows the dependency for a typical device.

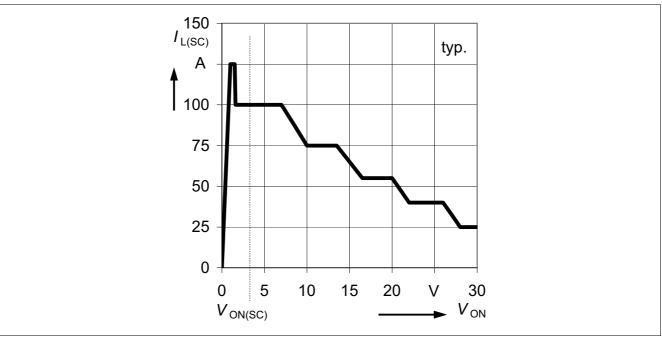


Figure 11 Typical Current Limitation

Depending on the severity of the short condition as well as on the battery voltage the resulting voltage drop across the device varies.

Whenever the resulting voltage drop  $V_{\rm ON}$  exceeds the short circuit detection threshold  $V_{\rm ON(SC)}$ , the device will switch off immediately and latch until being reset via the input. The  $V_{\rm ON(SC)}$  detection functionality is activated, when  $V_{\rm blN} > 10$  V typ. and the blanking time  $t_{\rm d(SC1)}$  expired after switch on.

In the event that either the short circuit detection via  $V_{\rm ON(SC)}$  is not activated or that the on chip temperature sensor senses overtemperature before the blanking time  $t_{\rm d(SC1)}$  expired, the device switches off resulting from overtemperature detection. After cooling down with thermal hysteresis, the device switches on again. The device will react as during normal switch on triggered by the input signal. Please refer to **Figure 12** and **Figure 19** for details.

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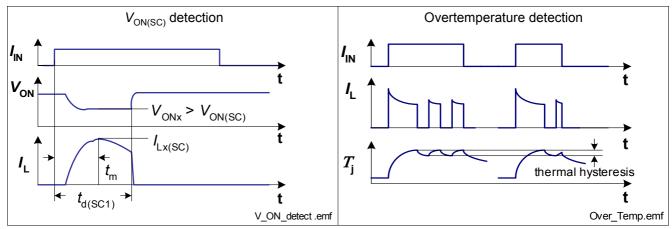


Figure 12 Overload Behavior

# 6.2 Short circuit impedance

The capability to handle single short circuit events depends on the battery voltage as well as on the primary and secondary short impedance. **Figure 13** outlines allowable combinations for a single short circuit event of maximum, secondary inductance for given secondary resistance.

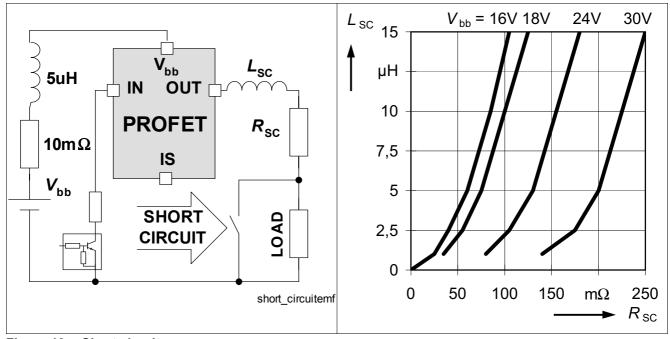


Figure 13 Short circuit

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# 6.3 Reverse Polarity Protection - Reversave™

The device can not block a current flow in reverse polarity condition. In order to minimize power dissipation, the device offers Reversave<sup>TM</sup> functionality. In reverse polarity condition the channel will be switched on provided a sufficient gate to source voltage is generated  $V_{\rm GS} \approx V_{\rm Rbb}$ . Please refer to **Figure 14** for details.

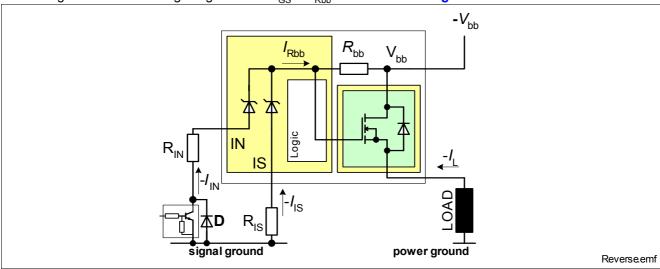


Figure 14 Reverse battery protection

Additional power is dissipated by the integrated  $R_{\rm bb}$  resistor. Use following formula for estimation of overall power dissipation  $P_{\rm diss(rev)}$  in reverse polarity mode.

$$P_{\text{diss(rev)}} \approx R_{\text{ON(rev)}} \cdot I_{\text{L}}^2 + R_{\text{bb}} \cdot I_{\text{Rbb}}^2$$

For reverse battery voltages up to  $V_{\rm bb}$  < 16 V the pin IN or the pin IS should be low ohmic connected to signal ground. This can be achieved e.g. by using a small signal diode D in parallel to the input switch or by using a small signal MOSFET driver. For reverse battery voltages higher then  $V_{\rm bb}$  = 16 V an additional resistor  $R_{\rm IN}$  is recommended. The overall current through  $R_{\rm bb}$  should not be above 80 mA.

$$\frac{1}{R_{\text{IN}}} + \frac{1}{R_{\text{IS}}} = \frac{0.08A}{\left|V_{\text{bb}}\right| - 12V}$$

Note: No protection mechanism is active during reverse polarity. The IC logic is not functional.

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# 6.4 Overvoltage Protection

Beside the output clamp for the power stage as described in **Section 5.3** there is a clamp mechanism implemented for all logic pins. See **Figure 15** for details.

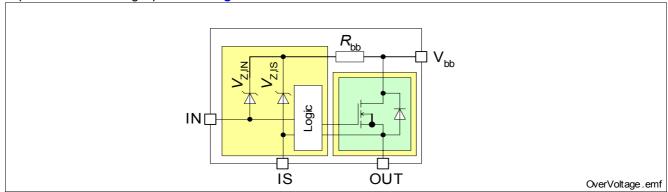


Figure 15 Overvoltage Protection

#### 6.5 Loss of Ground Protection

In case of complete loss of the device ground connections the BTS50080-1TEA securely changes to or remains in off state.

# 6.6 Loss of $V_{\rm bb}$ Protection

In case of complete loss of  $V_{bb}$  the BTS50080-1TEA remains in off state.

In case of loss of  $V_{bb}$  connection with charged inductive loads a current path with load current capability has to be provided, to demagnetize the charged inductances. It is recommended to use a diode, a Z-diode, or a varistor ( $V_{ZL}+V_D$  < 30 V or  $V_{Zb}+V_D$  < 16 V if  $R_{IN}$  = 0). For higher clamp voltages currents through IN and IS have to be limited to -140 mA. Please refer to **Figure 16** for details.

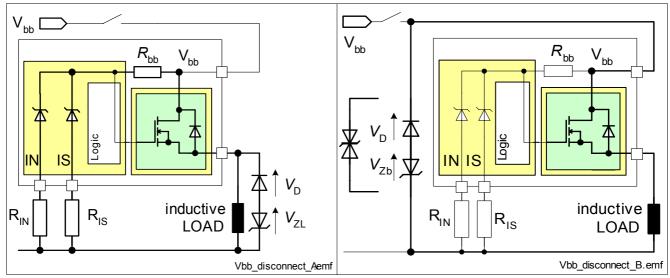


Figure 16 Loss of  $V_{\rm bb}$ 



# 6.7 Electrical Characteristics

 $V_{\rm bb}$  = 12 V,  $T_{\rm j}$  = -40 ... 150 °C (unless otherwise specified) Typical values are given at  $V_{\rm bb}$  = 12 V,  $T_{\rm j}$  = 25 °C

Pos.	Parameter	Symbol	L	imit Valu	ues	Unit	Conditions
			Min.	Тур.	Max.		
Overloa	ad Protection						
6.7.1	Load current limitation peak <sup>1) 2)</sup>	$I_{\rm Lpeak(SC)}$				Α	$V_{\rm ON}$ = 1.5 V,
	$T_{\rm i}$ = -40 °C	, , ,	-	180	220		(Tab to pin 1 and 5)
	$T_{i} = +25  ^{\circ}\text{C}$		-	125	-		
	$T_{j} = +150  ^{\circ}\text{C}$		70	90	-		
6.7.2	Load current limitation <sup>2)</sup>	$I_{\rm L12(SC)}$				Α	$V_{ON} = 12 \text{ V},$
	$T_{\rm i}$ = -40 °C	2.2(00)	_	80	110		$t_{\rm m}$ = 170 µs,
	$T_{i} = +25  ^{\circ}\text{C}$		_	75	-		(Tab to pin 1 and 5)
	T <sub>i</sub> = +150 °C		45	60	-		
6.7.3	Load current limitation <sup>1) 2)</sup>	$I_{\rm L18(SC)}$				Α	$V_{\rm ON}$ = 18 V,
	T <sub>i</sub> = -40 °C	210(00)	_	60	80		(Tab to pin 1 and 5)
	$T_{i}^{J} = +25  ^{\circ}\text{C}$		_	55	-		,
	$T_{i}^{J}$ = +150 °C		33	50	-		
6.7.4	Load current limitation 2)	$I_{\text{L24(SC)}}$				Α	$V_{ON} = 24 \text{ V},$
	T <sub>i</sub> = -40 °C	-L24(SC)	_	40	60		$t_{\rm m} = 170 \ \mu s,$
	$T_i = +25 ^{\circ}\text{C}$		_	40	-		(Tab to pin 1 and 5)
	$T_{i} = +150  ^{\circ}\text{C}$		20	35	_		(
6.7.5	Load current limitation <sup>1) 2)</sup>	$I_{\rm L30(SC)}$				Α	V <sub>ON</sub> = 30 V,
0.7.0	$T_i = -40  ^{\circ}\text{C}$	1L30(SC)	_	25	40	, ,	(Tab to pin 1 and 5)
	$T_i = +25 ^{\circ}\text{C}$		_	25	_		( ab to pin i and o)
	$T_{\rm i}$ = +150 °C		15	25	_		
6.7.6	Short circuit shutdown detection	V	2.5	3.5	4.5	V	$V_{\text{bIN}}$ > 10 V typ.,
0.7.0	voltage 1)	$V_{ON(SC)}$	2.5	0.0	4.5	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	$T_{\rm j} = 25  ^{\circ}\text{C}$
6.7.7	Short circuit shutdown delay after	+	350	650	1200	110	•
0.7.7	input current pos. slope <sup>3)</sup>	$t_{d(SC1)}$	330	030	1200	μs	$V_{\rm ON} > V_{\rm ON(SC)}$
0.7.0	<u>'</u>	T	450	475		00	
6.7.8	Thermal shut down temperature	$T_{j(SC)}$	150	175 1)	-	°C	-
6.7.9	Thermal hysteresis 1)	$\Delta T_{\rm i}$	_	10	_	K	_
	,	الما		1 .0			
	e Polarity		1			1	
6.7.10	On-State resistance in case of	$R_{ON(rev)}$				$m\Omega$	$V_{\text{IN}} = 0 \text{ V},$
	reverse polarity						$I_{\rm L}$ = -7.5 A,
	$V_{\rm bb} = -8 \text{ V}, T_{\rm j} = 25  ^{\circ}\text{C}^{-1}$		-	9.5	-		$R_{\rm IS}$ = 1 k $\Omega$ ,
	$V_{\rm bb} = -8 \text{ V}, T_{\rm j} = 150  ^{\circ}\text{C}^{-1}$		-	16	20		(pin 1 and 5 to TAB)
	$V_{\rm bb}$ = -12 V, $T_{\rm j}$ =25 °C		-	9	-		
	$V_{\rm bb}$ = -12 V, $T_{\rm j}$ =150 °C		-	15	18		
6.7.11	Integrated resistor in $V_{\rm bb}$ line	$R_{bb}$	-	100	150	Ω	$T_{\rm j}$ = 25 °C
Overvo	ltage						
6.7.12	Overvoltage protection	$V_{Z}$				V	$I_{\rm bb}$ = 15 mA
	Input pin	$V_{Z,IN}$	63	67	_	V	
	Sense pin		63	67		V	
	subject to production test, specified by de	$V_{Z,IS}$	03	01	-	V	

<sup>1)</sup> Not subject to production test, specified by design



# Smart High-Side Power Switch BTS50080-1TEA

**Protection Functions** 

- 2) Short circuit current limit for max. duration of  $t_{d(SC1)}$ , prior to shutdown, see also **Figure 12**.
- 3) min. value valid only if input "off-signal" time exceeds 30  $\mu s$



**Diagnosis** 

# 7 Diagnosis

For diagnosis purpose, the BTS50080-1TEA provides an enhanced sense signal at the pin IS.

The pin IS provides during normal operation a sense current, which is proportional to the load current as long as  $V_{\rm bIS} > 5$  V. The ratio of the output current is defined as  $k_{\rm ILIS} = I_{\rm L}/I_{\rm IS}$ . During switch-on no current is provided, until the forward voltage drops below  $V_{\rm ON} < 1$  V typ. The output sense current is limited to  $I_{\rm IS(lim)}$ .

The pin IS provides in case of any fault conditions a defined fault current  $I_{\rm IS(fault)}$  as long as  $V_{\rm bIS}$  > 8 V. Fault conditions are overcurrent ( $V_{\rm ON}$  > 1 V typ.), current limit or overtemperature switch off.

The pin IS provides no current during open load in ON and de-energisation of inductive loads.

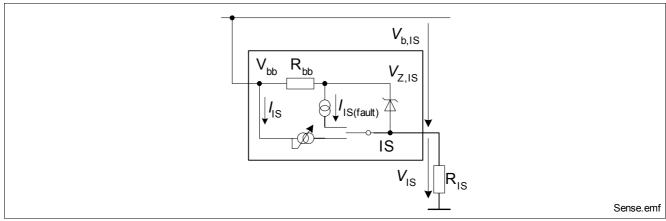


Figure 17 Block Diagram: Diagnosis

Table 1 Truth Table

Parameter	Input Current Level	<b>Output Level</b>	Current Sense I <sub>Is</sub>
Normal operation	L <sup>1)</sup>	L	$\approx 0 \ (I_{\rm IS(LL)})$
	H <sup>1)</sup>	Н	nominal
Overload	L	L	$\approx 0 \ (I_{\rm IS(LL)})$
	Н	Н	$I_{IS(fault)}$
Short circuit to GND	L	L	$\approx 0 \ (I_{\rm IS(LL)})$
	Н	L	$I_{IS(fault)}$
Overtemperature	L	L	≈ 0 ( <i>I</i> <sub>IS(LL)</sub> )
	Н	L	$I_{IS(fault)}$
Short circuit to $V_{\mathrm{bb}}$	L	Н	$\approx 0 (I_{\rm IS(II)})$
	Н	Н	< nominal <sup>2)</sup>
Open load	L	Z <sup>1)</sup>	$\approx 0 \ (I_{\rm IS(LL)})$
	Н	Н	$\begin{array}{l} \approx 0 \ (I_{\rm IS(LL)}) \\ \approx 0 \ (I_{\rm IS(LH)}) \end{array}$

<sup>1)</sup> H = "High" Level, L = "Low" Level, Z = high impedance, potential depends on external circuit

The accuracy of the provided current sense ratio ( $k_{\rm ILIS}$  =  $I_{\rm L}$  /  $I_{\rm IS}$ ) depends on the load current. Please refer to Figure 18 for details. A typical resistor  $R_{\rm IS}$  of 1 k $\Omega$  is recommended.

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<sup>2)</sup> Low ohmic short to  $V_{\rm bb}$  may reduce the output current  $I_{\rm L}$  and therefore also the sense current  $I_{\rm IS}$ .



**Diagnosis** 

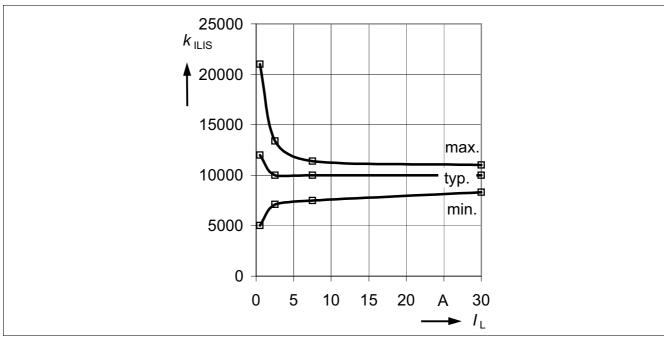


Figure 18 Current sense ratio  $k_{\rm ILIS}^{1}$ 

Details about timings between the diagnosis signal  $I_{\rm IS}$ , the forward voltage drop  $V_{\rm ON}$  and the load current  $I_{\rm L}$  in ON-state can be found in **Figure 19**.

Note: During operation at low load current and at activated forward voltage drop limitation the "two level control" of  $V_{\mathsf{ON}(\mathsf{NL})}$  can cause a sense current ripple synchronous to the "two level control" of  $V_{\mathsf{ON}(\mathsf{NL})}$ . The ripple frequency increases at reduced load currents.

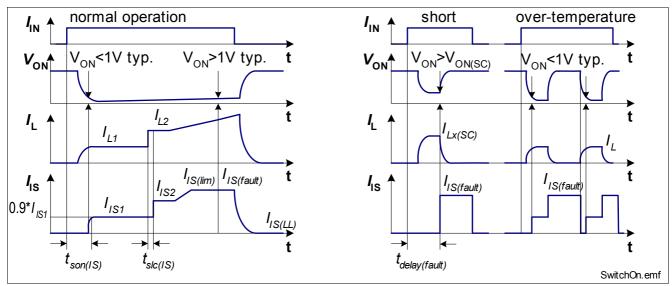


Figure 19 Timing of Diagnosis Signal in ON-state

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<sup>1)</sup> The curves show the behavior based on characterization data. The marked points are guaranteed in this Datasheet in Section 7.1 (Position 7.1.1).



Diagnosis

# 7.1 Electrical Characteristics

 $V_{\rm bb}$  = 12 V,  $T_{\rm i}$  = -40 ... 150 °C (unless otherwise specified) Typical values are given at  $V_{\rm bb}$  = 12 V,  $T_{\rm i}$  = 25 °C

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Тур.	Max.		
Load C	urrent Sense						
7.1.1	Current sense ratio, static on- condition	$k_{ILIS}$	-	10	-	k	$V_{\rm IN} = 0 \text{ V},$ $I_{\rm IS} < I_{\rm IS(lim)}$
	I <sub>I</sub> =30A		8.3	9.7	11		, ,
	I_=7.5A		7.5	9.7	11.4		
	$I_{\rm L}$ =2.5A		7.1	9.7	13.4		
	I <sub>L</sub> =0.5A		5	12	21		
	$I_{\rm IN}$ = 0 (e.g. during de energizing of inductive loads) <sup>1)</sup>		disabled			-	-
7.1.2	Sense saturation current 1)	$I_{\rm IS(lim)}$	4.0	6	7.5	mA	$V_{\rm ON}$ < 1 V, typ.
7.1.3	Sense current under fault conditions	$I_{\rm IS(fault)}$	4.0	5.2	7.5	mA	$V_{\rm ON}$ > 1 V, typ.
7.1.4	Current sense leakage current	$I_{\rm IS(LL)}$	_	0.1	0.5	μΑ	$I_{IN} = 0$
7.1.5	Current sense offset current	$I_{\rm IS(LH)}$	_	0.1	1	μΑ	$V_{\rm IN}$ = 0, $I_{\rm L} \le 0$
7.1.6	Current sense settling time to 90% $I_{\rm IS\_stat.}$ <sup>1)</sup>	$t_{\rm son(IS)}$	_	250	500	μs	<i>I</i> <sub>L</sub> = 0 _ □ 20 A
7.1.7	Current sense settling time to 90% $I_{\rm IS\_stat.}^{\rm 1)}$	$t_{\rm slc(IS)}$	_	50	100	μs	<i>I</i> <sub>L</sub> = 10 _ □ 20 A
7.1.8	Fault-Sense signal delay after input current positive slope	$t_{\rm delay(fault)}$	350	650	1200	μs	$V_{\rm ON}$ > 1 V, typ.

<sup>1)</sup> Not subject to production test, specified by design



**Package Outlines** 

# 8 Package Outlines

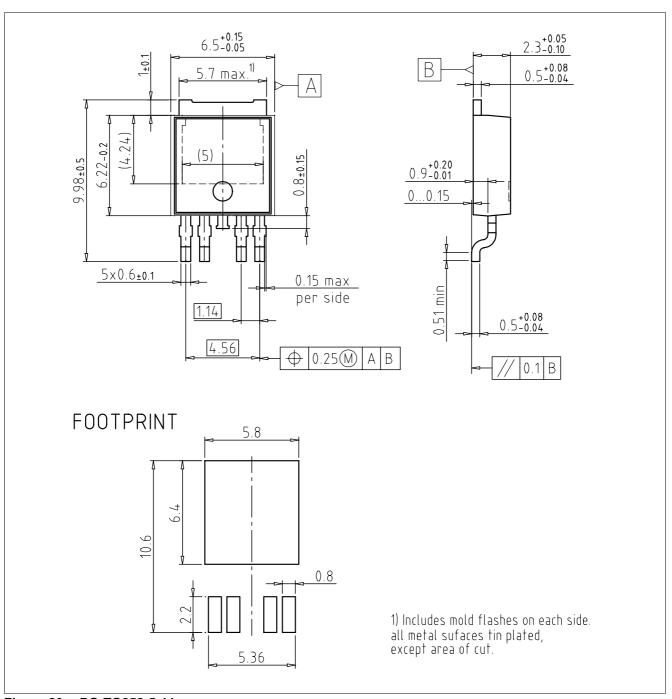


Figure 20 PG-TO252-5-11

#### **Green Product**

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Packages": http://www.infineon.com/packages.

Dimensions in mm





**Revision History** 

# 9 Revision History

Version	Date	Changes
Data sheet	2008-08-22	Initial version of data sheet.
Rev. 1.0		

Datasheet 25 Rev. 1.0, 2008-08-28

Edition 2008-08-28

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